Lean Manufacturing in Industry 4.0

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Deadline for manuscript
submissions:
30 June 2024

Message from the Guest Editors

Dear Colleagues,

This Special Issue particularly looks forward to articles addressing, among other topics, the implementation of lean principles in smart factories, the synergy between lean practices and cyber-physical systems, the role of data science in waste reduction, and the challenges of workforce upskilling in the face of rapidly evolving technologies. Contributions to this Special Issue should highlight the latest advancements in lean manufacturing strategies, as well as the ongoing challenges of integrating these approaches within Industry 4.0. By examining successful implementations and addressing potential pitfalls, this Special Issue aims to provide valuable insights for practitioners and researchers seeking to optimize production processes in the era of smart manufacturing. We are interested in studies using any of the full range of qualitative and quantitative investigative methodologies.

For detailed information, please visit:
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mdpi.com/si/168940

Special Issue

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Message from the Editor-in-Chief

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